

L Number	Hits	Search Text	DB	Time stamp
1	2	("5295045").PN.	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:30
2	2749	(174/52.1).CCLS.	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:17
3	97	361/803.ccls. and mold\$3	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:20
4	614	174/52.2.ccls. and packag\$3	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:21
5	5	5295045.URPN.	USPAT	2004/03/21 10:30
6	1749	(174/261).CCLS.	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:33
7	12311	first near board	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:33
8	5151	(first near board) and (second near board)	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:34
9	41	((first near board) and (second near board)) and (mold\$3 adj housing)	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:36
10	317	361/801-802.ccls. and mold\$3	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/21 10:37
11	5	("4354724" "5387132" "RE35344" "5888086" "6045407").PN.	USPAT	2004/03/21 10:40
12	9	("3740698" "4505528" "4660920" "4983132" "4995825" "5094624" "5161995" "5277621" "5588878").PN.	USPAT	2004/03/21 10:41
13	8	("4812793" "5943218" "5969946" "6054648" "6056579" "6074237" "6171131" "6176727").PN.	USPAT	2004/03/21 10:44

L Number	Hits	Search Text	DB	Time stamp
1	4	((("6224405") or ("5295045")).PN.	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:36
2	2	6224405.URPN.	USPAT	2004/03/20 13:10
3	7	("5057029" "5421737" "5443395" "5791920" "5801926" "5906497" "6075702").PN.	USPAT	2004/03/20 13:11
4	9	("5014113" "5034800" "5049527" "5049977" "5064968" "5101324" "5157771" "5161304" "5166866").PN.	USPAT	2004/03/20 13:11
5	458	(439/160).CCLS.	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:15
6	8536	mold\$3 near housing	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:16
7	2300	(mold\$3 near housing) and (board or substrate)	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:17
8	1390	((mold\$3 near housing) and (board or substrate)) and components	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:17
9	775	(mold\$3 near housing) and (boards or substrates)	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:17
10	519	((mold\$3 near housing) and (boards or substrates)) and components	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:31
11	1056	439/\$.ccls. and (mold\$3 adj housing)	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:32
12	62	(439/\$.ccls. and (mold\$3 adj housing)) and (second near (board or substrate))	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:32
13	323	(439/152).CCLS.	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:41
14	442	361/\$.ccls. and brace	USPAT; EPO; JPO; DERWENT; USOCR	2004/03/20 13:42